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Kind regards,

Team Nexperia



40 V, 600 mA, PNP switching transistor 5 March 2015

**Product data sheet** 

### 1. General description

PNP switching transistor in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

NPN complement: PMBT4401

### 2. Features and benefits

- Single general-purpose switching transistor
- AEC-Q101 qualified

### 3. Applications

• Switching and linear amplification

### 4. Quick reference data

Table 1. Q	uick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	-40	V
I <sub>C</sub>	collector current		-	-	-600	mA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = -2 V; $I_C$ = -150 mA; $T_{amb}$ = 25 °C	100	-	300	

### 5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	3	C
2	E	emitter		в
3	С	collector	1 2 TO-236AB (SOT23)	E sym132





#### 40 V, 600 mA, PNP switching transistor

# 6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PMBT4403	TO-236AB	plastic surface-mounted package; 3 leads	SOT23				

# 7. Marking

Table 4. Marking codes	
Type number	Marking code
	[1]
PMBT4403	%2T

[1] % = placeholder for manufacturing site code

40 V, 600 mA, PNP switching transistor

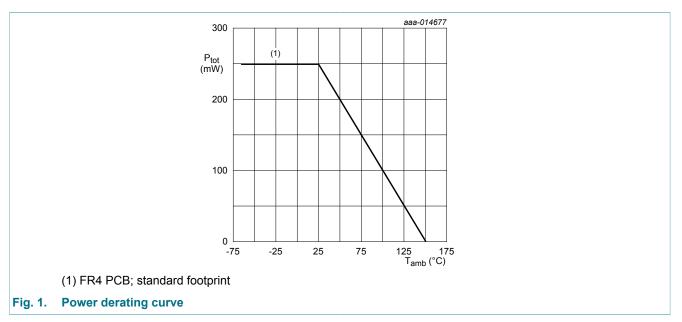
#### **Limiting values** 8.

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter		-	-40	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-40	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	-5	V
I <sub>C</sub>	collector current			-	-600	mA
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-800	mA
I <sub>BM</sub>	peak base current			-	-200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	250	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-65	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

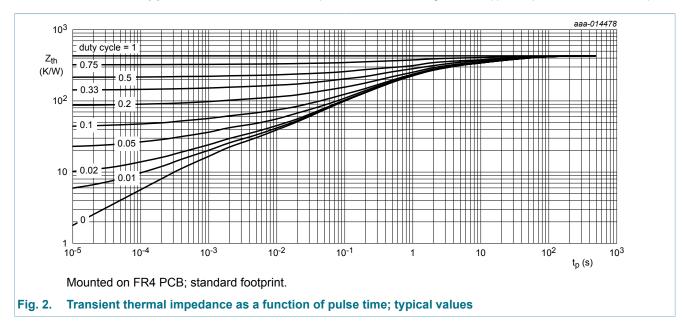
[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.



#### **Thermal characteristics** 9.

Table 6.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1]	-	-	500	K/W
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#### 40 V, 600 mA, PNP switching transistor



[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

40 V, 600 mA, PNP switching transistor

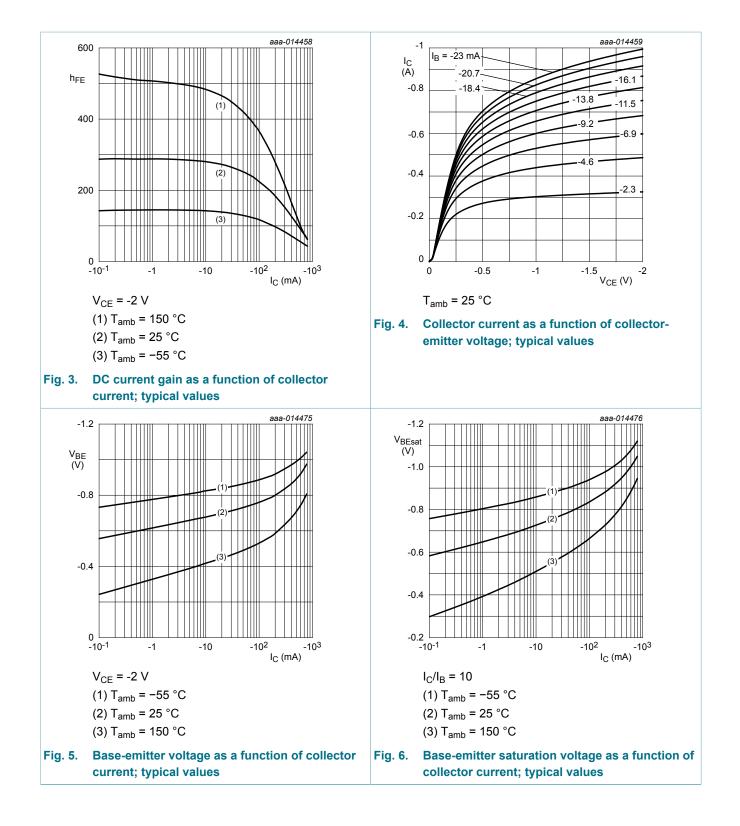
### **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB}$ = -40 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	-50	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB}$ = -5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	-50	nA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = -1 V; I <sub>C</sub> = -0.1 mA; T <sub>amb</sub> = 25 °C	30	-	-	
		$V_{CE}$ = -1 V; I <sub>C</sub> = -1 mA; T <sub>amb</sub> = 25 °C	60	-	-	
		$V_{CE}$ = -1 V; I <sub>C</sub> = -10 mA; T <sub>amb</sub> = 25 °C	100	-	-	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -150 mA; T <sub>amb</sub> = 25 °C	100	-	300	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -500 mA; T <sub>amb</sub> = 25 °C	20	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = -150 mA; I <sub>B</sub> = -15 mA; T <sub>amb</sub> = 25 °C	-	-	-400	mV
		I <sub>C</sub> = -500 mA; I <sub>B</sub> = -50 mA; T <sub>amb</sub> = 25 °C	-	-	-750	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = -150 mA; I <sub>B</sub> = -15 mA; T <sub>amb</sub> = 25 °C	-	-	-950	mV
		I <sub>C</sub> = -500 mA; I <sub>B</sub> = -50 mA; T <sub>amb</sub> = 25 °C	-	-	-1.3	V
t <sub>d</sub>	delay time	I <sub>C</sub> = -150 mA; I <sub>Bon</sub> = -15 mA;	-	-	15	ns
t <sub>r</sub>	rise time	I <sub>Boff</sub> = 15 mA; T <sub>amb</sub> = 25 °C	-	-	30	ns
t <sub>on</sub>	turn-on time	-	-	-	40	ns
t <sub>s</sub>	storage time	-	-	-	300	ns
t <sub>f</sub>	fall time	-	-	-	50	ns
t <sub>off</sub>	turn-off time	-	-	-	350	ns
C <sub>C</sub>	collector capacitance	V <sub>CB</sub> = -10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	-	8.5	pF
C <sub>E</sub>	emitter capacitance	V <sub>EB</sub> = -500 mV; I <sub>C</sub> = 0 A; i <sub>c</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	-	35	pF
f <sub>T</sub>	transition frequency	$V_{CE}$ = -10 V; I <sub>C</sub> = -20 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C	200	-	-	MHz

### **NXP Semiconductors**

# **PMBT4403**

#### 40 V, 600 mA, PNP switching transistor

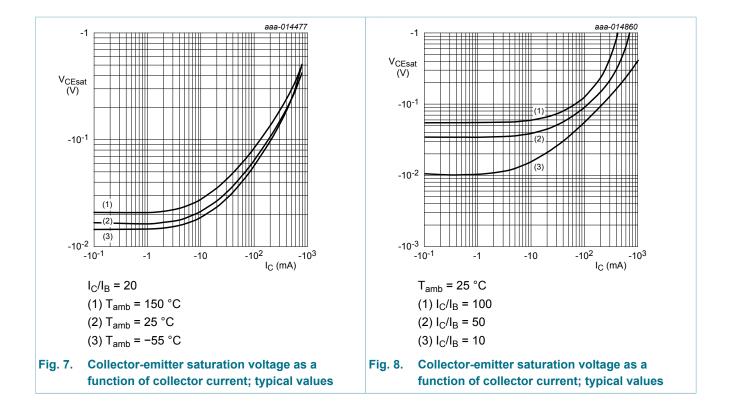


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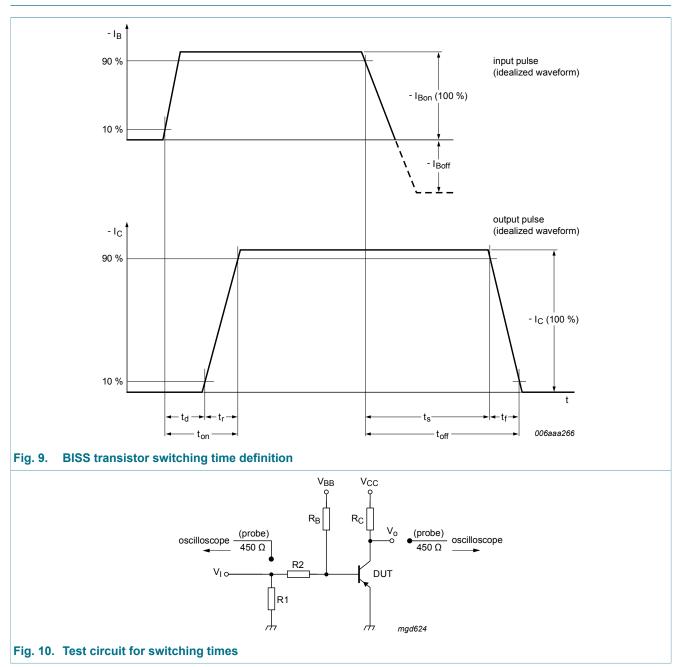
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# **PMBT4403**

#### 40 V, 600 mA, PNP switching transistor



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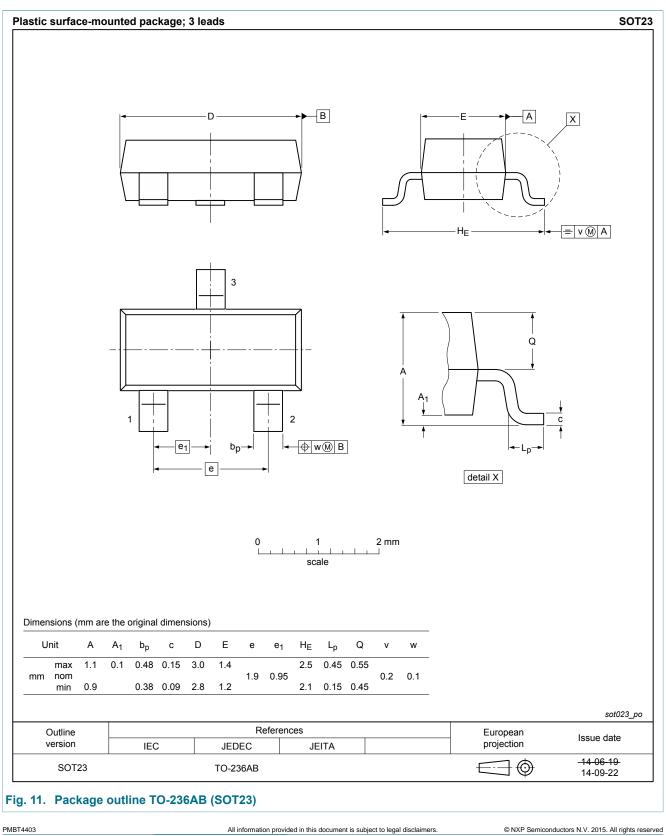
### 11. Test information

#### **11.1 Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

#### 40 V, 600 mA, PNP switching transistor

### 12. Package outline

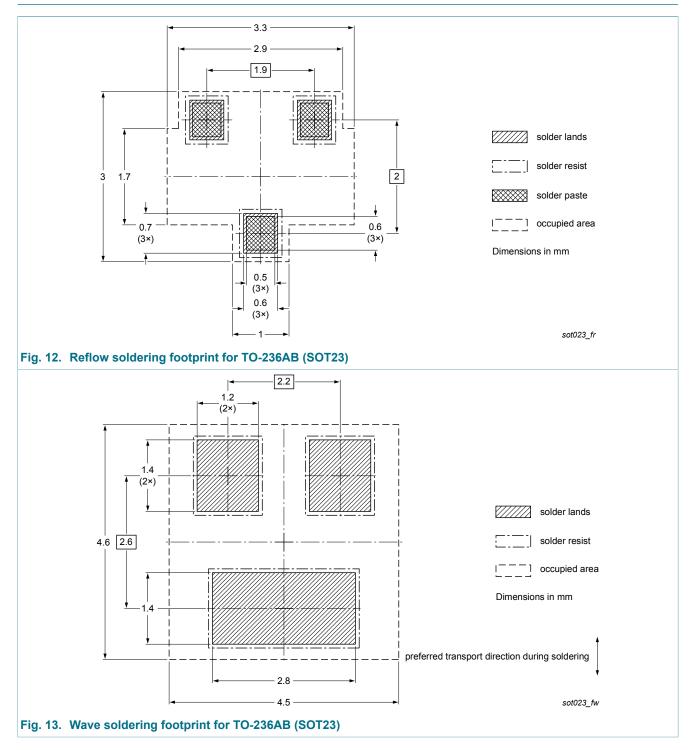


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#### 40 V, 600 mA, PNP switching transistor

### 13. Soldering



40 V, 600 mA, PNP switching transistor

# 14. Revision history

Table 8. Revision history								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMBT4403 v.5	20150305	Product data sheet	-	PMBT4403 v.4				
Modifications:	of NXP Semiconduc	ctors	signed to comply with the ompany name where app					
PMBT4403 v.4	20040121	Product data sheet	-	PMBT4403 v.3				
PMBT4403 v.3	19990415	Product specification	-	PMBT4403 v.2				
PMBT4403 v.2	19970505	Product specification	-	PMBT4403 v.1				
PMBT4403 v.1	19940901	Product specification	-	-				

#### 40 V, 600 mA, PNP switching transistor

### 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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#### 40 V, 600 mA, PNP switching transistor

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